

RELIABILITY MONITOR

PRODUCT	MONITOR DATE	DATE CODE	ASSEMBLY FACILITY	ASSEMBLY LOT NO	PROCESS TYPE	PACKAGE TYPE
DS1643 (w/BR1225)	Aug-97	9732 B2	DALLAS	DA096054	N/A	28 MODULE

STRESS/JOB NO.

READPOINT

(Sample Size/No. of Fails)

Hi Temp Storage 70°C, No Bias P-20237, P-20271	<u>0 Hr</u>	<u>336 Hr</u>	<u>1K Hr</u>	<u>Elect. Test</u>	<u>Cum %</u>
	90/0	20/0	20/0	20/0	0.0%

Temp Cycle 0°C to +70°C P-20272	<u>300 ~</u>	<u>1K ~</u>	<u>Elect. Test</u>	<u>Cum %</u>
	35/0	35/0		

Moisture Soak 60°C/90% RH P-20273	<u>288 Hr</u>	<u>960 Hr</u>	<u>Elect. Test</u>	<u>Cum %</u>
	35/0	35/0		

Phys. Dimen. <u>P-20236</u>	Solderability <u>P-20235</u>
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Failure Mode

Failure Analysis